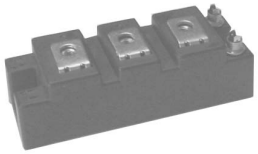
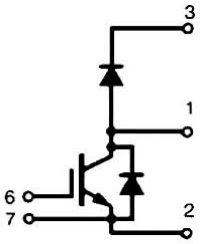
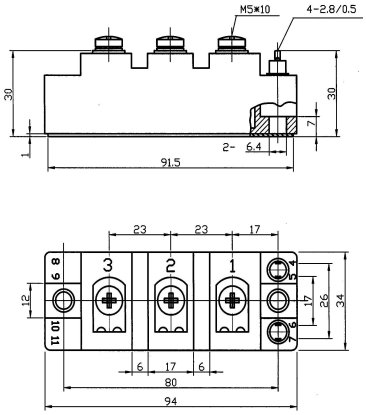
SID75N12

NPT IGBT Modules





Dimensions in mm (1mm = 0.0394")



Absolute Maximum Ratings $T_C = 25^oC$, unless otherwise specified

Symbol	Conditions	Values	Units
IGBT			
V_{CES}		1200	V
I_C	T_C= 25(80)^{o}C	75(60)	A
I_{CRM}	T_C= 25(80)^{o}C, t_P =1ms	150(120)	A
V_{GES}		±20	V
T_{Vj},(T_{stg})	$T_{OPERATION} \leq T_{stg}$	−40...+150(125)	^{o}C
V_{isol}	AC, 1min	2500	V
Inverse Diode			
$I_F = -I_C$	T_C= 25(80)^{o}C	75(50)	A
I_{FRM}	T_C= 25(80)^{o}C, t_P =1ms	150(120)	A
I_{FSM}	t_P =10ms; sin.;T_j=150^{o}C	550	A
Freewheeling diode			
$I_F = -I_C$	T_C= 25(80)^{o}C	95(65)	A
I_{FRM}	T_C= 25(80)^{o}C, t_P =1ms	150(120)	A
I_{FSM}	t_P =10ms; sin.;T_j=150^{o}C	720	A

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Characteristics $T_C = 25^oC$, unless otherwise specified

Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, I_C =2mA	4.5	5.5	6.5	V
I_{CES}	V_{GE} = 0; $V_{CE} = V_{CES}$; $T_j = 25(125)^oC$		0.1	0.3	mA
$V_{CE(TO)}$	$T_j = 25(125)^oC$		1.4(1.6)	1.6(1.8)	V
r_{CE}	V_{GE} = 15V, $T_j = 25(125)^oC$		22(30)	28(38)	mΩ
$V_{CE(sat)}$	I_C =100A; V_{GE} = 15V; chip level		2.5(3.1)	3(3.7)	V
C_{ies}	under following conditions		3.3	4.3	
C_{oes}	V_{GE} = 0, V_{CE} = 25V, f = 1MHz		0.5	0.6	nF
C_{res}			0.22	0.3	
L_{CE}				30	nH
$R_{CC'+EE'}$	res., terminal-chip $T_C = 25(125)^oC$		0.75(1)		mΩ
	under following conditions:				
$t_{d(on)}$	V_{CC} = 600V, I_C = 75A		44	100	ns
t_r	$R_{Gon} = R_{Goff}$ = 22Ω, $T_j = 125^oC$		56	100	ns
$t_{d(off)}$	V_{GE} = ± 15V		380	500	ns
t_f			70	100	ns
$E_{on}(E_{off})$			8(5)		mJ
Inverse Diode	under following conditions:				
$V_F = V_{EC}$	I_F = 75A; V_{GE} = 0V; $T_j = 25(125)^oC$		2(1.8)	2.5	V
$V_{(TO)}$	$T_j = 125^oC$			1.2	V
r_T	$T_j = 125^oC$		18	22	mΩ
I_{RRM}	I_F = 50A; $T_j = 25(125)^oC$		23(35)		A
Q_{rr}	di/dt = 800A/us				uC
E_{rr}	V_{GE} = V				mJ
FWD	under following conditions:				
$V_F = V_{EC}$	I_F = 50A; V_{GE} = 0V; $T_j = 25(125)^oC$		1.85(1.6)	2.2	V
$V_{(TO)}$	$T_j = 125^oC$			1.2	V
r_T	$T_j = 125^oC$		12	15	mΩ
I_{RRM}	I_F =50A; $T_j = 25^oC$		27(40)		A
Q_{rr}	di/dt = A/us				uC
E_{rr}	V_{GE} = V				mJ
Thermal Characteristics					
$R_{th(j-c)}$	per IGBT			0.27	K/W
$R_{th(j-c)D}$	per Inverse Diode			0.6	K/W
$R_{th(j-c)FD}$	per FWD			0.5	K/W
$R_{th(c-s)}$	per module			0.05	K/W
Mechanical Data					
M_s	to heatsink M6	3		5	Nm
M_t	to terminals M5	2.5		5	Nm
w				160	g

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